

# **Product Change Notification / BLAS-15SQVS234**

Date:

01-Mar-2024

PCN Type:

Manufacturing Change

# **Notification Subject:**

CCB 6748.001 Final Notice: Qualification of INMK as a new fabrication site for selected Microsemi Power Module devices available in 1200V IGBT2 in NPT Technology Bare Die products.

## **Affected CPNs:**

BLAS-15SQVS234\_Affected\_CPN\_03012024.pdf BLAS-15SQVS234\_Affected\_CPN\_03012024.csv

## **Notification Text:**

**PCN Status:**Final Notification

**PCN Type:**Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of INMK as a new fabrication site for selected Microsemi Power Module devices available in 1200V IGBT2 in NPT Technology Bare Die products.

# **Pre and Post Change Summary:**

	Pre Change	Post Change
Fabrication Site	Infineon Technologies Austria AG	Infineon Technologies (Kulim) Sdn. Bhd.
	(INFA)	(INMK)
Wafer Diameter	6 Inches	8 Inches

Certification

ISO-9001 / IATF16949

ISO-9001

### Impacts to Data Sheet:None

Change Impact:None

**Reason for Change:**To improve on-time delivery performance by qualifying INMK as a new fabrication site.

**Change Implementation Status:**In Progress

Estimated First Ship Date: April 16, 2024 (date code: 2416)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

### **Time Table Summary:**

	February 2024					۸	April 2024				
Workweek	05	06	07	08	09		14	15	16	17	18
Qual Report Availability					Х						
Final PCN Issue Date					Х						
Estimated Implementation Date									Х		

#### Method to Identify Change:Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

Revision History: February 29, 2024: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### **Attachments:**

PCN_BLAS-15SQVS234_Qual Report.pdf
Please contact your local Microchip sales office with questions or concerns regarding this notification.
Terms and Conditions:
If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.
If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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#### Affected Catalog Part Numbers (CPN)

APTGF100A120DTWG

APTGF100A120TG

APTGF100DA120T1G

APTGF150A120DG

APTGF150A120T3AG

APTGF150A120TG

APTGF150DH120G

APTGF150H120G

APTGF200SK120G

APTGF25H120T1G

APTGF25H120T3G

APTGF25SK120CT1G

APTGF25X120T3G

APTGF300A120G

APTGF300SK120G

APTGF300U120DG

APTGF50DSK120T3G

APTGF75DSK120TG

APTGF75H120TG

CMANGF300DA120T6G

CMANGF300SK120T6G

CMANGF75H120G

CMFIGF100V120G

CMGEGF400U120D4AG

CMHSLGF100X120BTAMG-AS

CMHUGF300DA120C20TAG

CMHUGF300SK120C15TG

CMHUGF300SK120C20TAG

CMHUGF300U120DC20TG

CMMVGF100V120T3AG

CMSEGF50DU120T3AG

CMHUGF300U120DC30TG

Date: Thursday, February 29, 2024